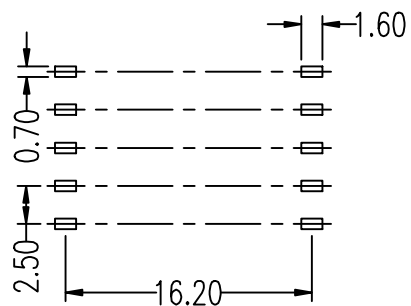
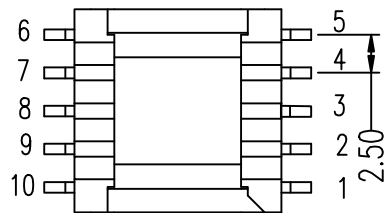
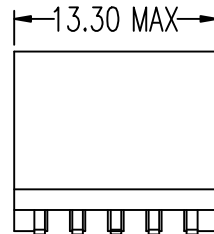
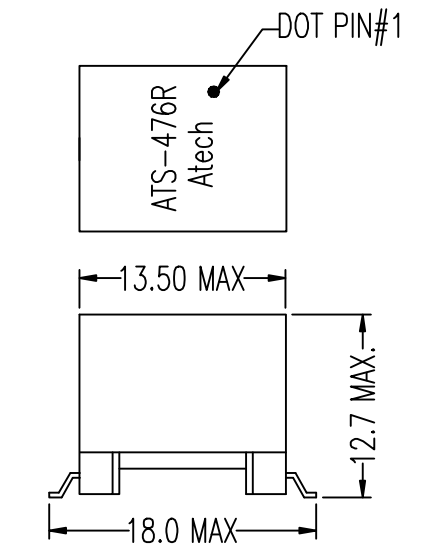
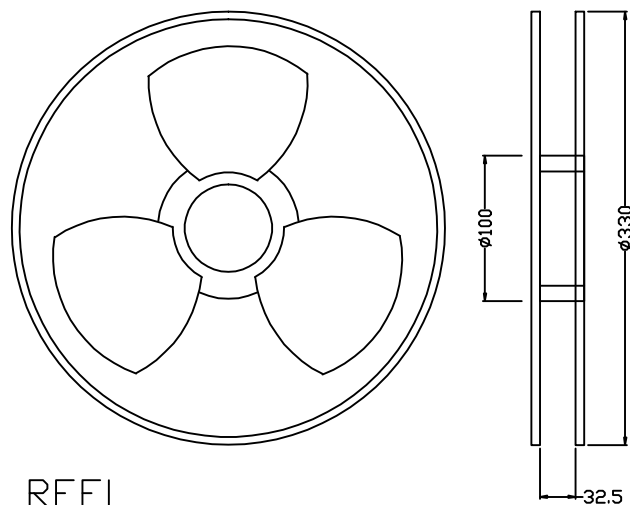
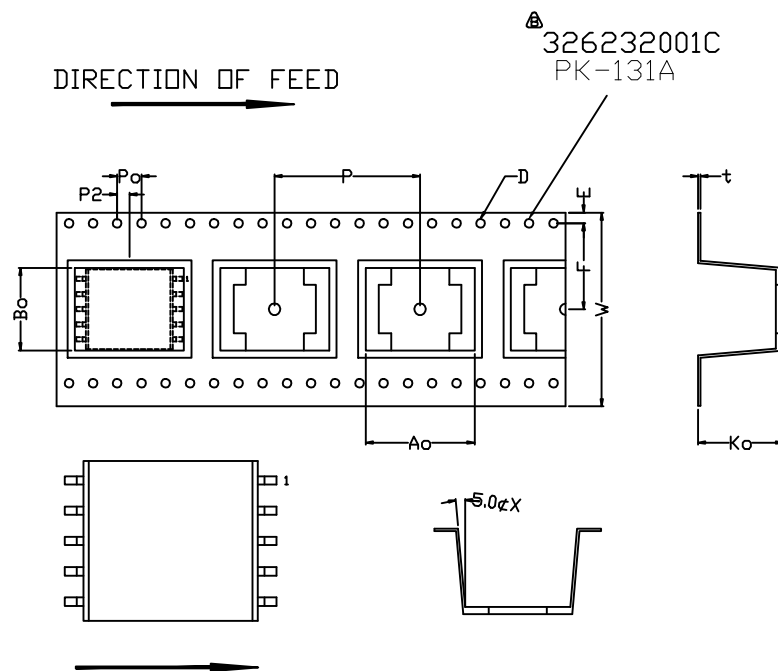


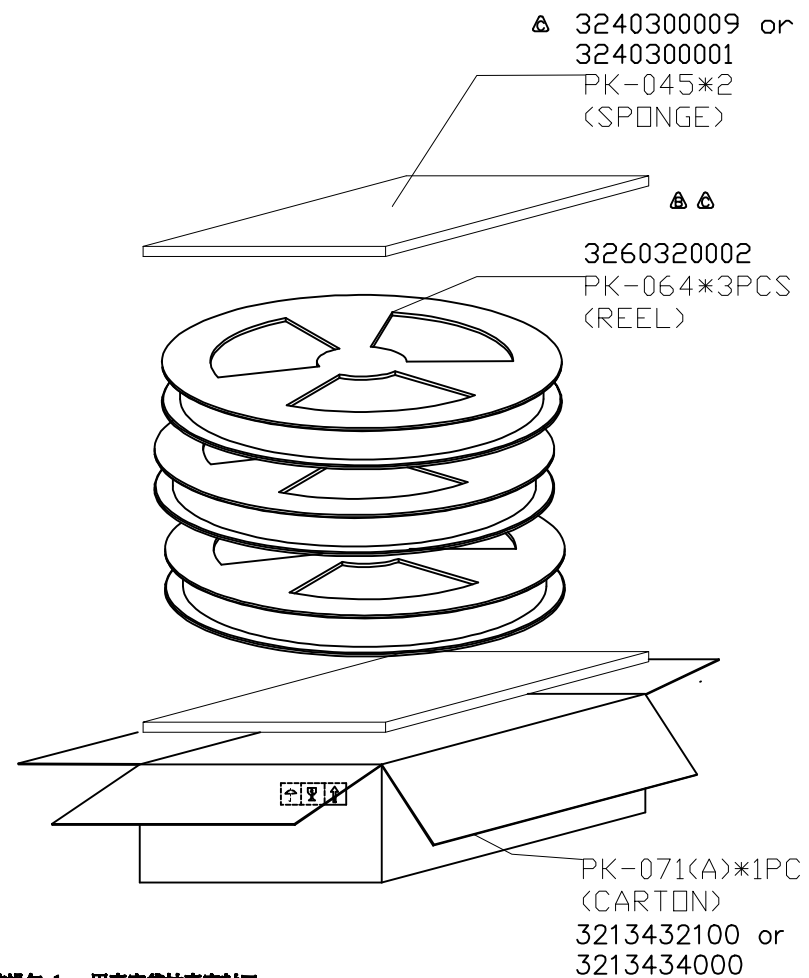
ELECTRICAL CHARACTERISTICS : (FOR C1626 COMPATIBLE)

1. DCR : 1-4 = 2-5 = $1.1\Omega \pm 10\%$ 9-7 = $0.21\Omega \pm 10\%$
2. INDUCTANCE : (@10KHz, 0.1Vrms) 1-5 (2-4 SHORT) = $3mH \pm 6\%$
3. LEAKAGE INDUCTANCE : (@100KHz, 0.1Vrms) 1-5 (2-4, 7-9 SHORT) = $15uH \text{ MAX.}$
4. TURN RATIO : (@1MHz, 1Vrms) 1-5 (2-4 SHORT) : 9-7 = $5.4 \pm 1\%$
5. INSERTION LOSS : (@100KHz, 0 dBm) = 0.8 dB MAX
6. FREQ. RESP. : (@REF 100KHz) @17KHz = $\pm 0.5dB$ @600KHz = $\pm 0.5dB$
7. HI-POT (@2500VAC, 0.5mA, 1SEC) 1-9, 2-9.
8. Cw(@100KHz, 0.1Vrms) 1-9 (W/H 2-4 SHORT) = $60pF \text{ MAX.}$
9. RoHS COMPLIANCE.

C	CHANGE MARKING SIDE	07/03/2007	PAIR	VINCENT	EUGENE	 Link & Power up Your Life II	TITLE HDL2 TRANSFORMER	
B	MARKING ADD "R"	06/26/2007	PAIR	VINCENT	EUGENE		DWG. NO.	
A	PCB LAYOUT 1.6mm	06/15/2006	PAIR	AL	EUGENE		ATS-476R	
	RELEASE	09/09/2005	BART	LYS	SUEDY	UNITS: M/M	SAFETY	
NO:	DESCRIPTION	DATE	BY	CHK	APPD	DATE	P/N:	SHEET 1 OF 1
REVISIONS						09/09/05	CTA41303AA	PAIR



ONE REEL 200 PCS
ONE CARTON 3 REEL (600 PCS)



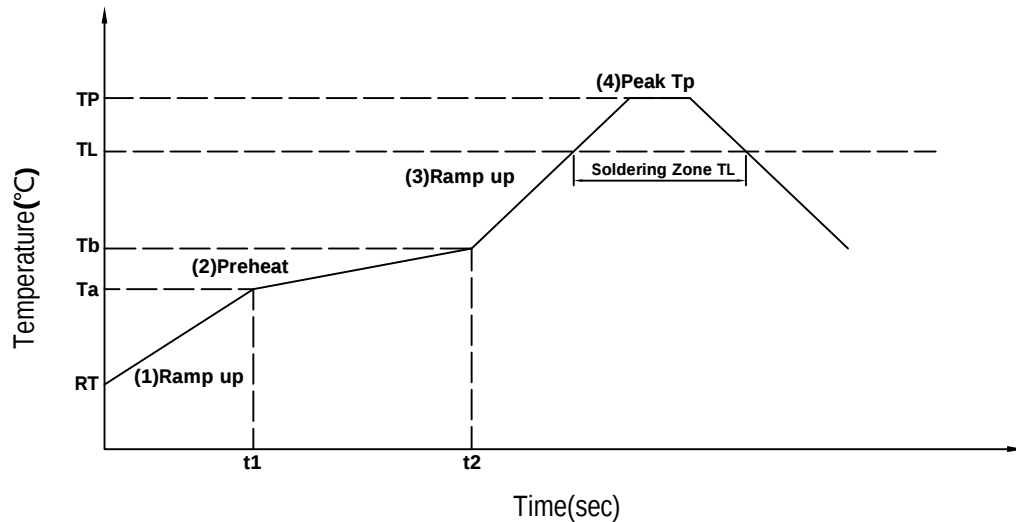
每箱放乾燥包 1pc 用真空袋抽真空封口
2780000000 3255048421 or 3255048420

ITEM	W	Ao	Bo	Ko	P	F	E	D	D1	Po	P2	t
DIM	32.00 $+0.30$ -0.30	18.00 $+0.10$ -0.10	13.60 $+0.10$ -0.10	14.10 $+0.10$ -0.10	24.00 $+0.10$ -0.10	14.20 $+0.10$ -0.10	1.75 $+0.10$ -0.10	1.50 $+0.10$ -0.00	2.00 $+0.25$ -0.00	4.00 $+0.10$ -0.10	2.00 $+0.10$ -0.10	0.40 $+0.05$ -0.05

C	CHANGE PART NO.	03/06/2012	SHIRLEY	JOAN	JOAN		TITLE		PACKING	
B	CHANGE PART NO.	03/11/2011	SHIRLEY	DICK	DICK		DWG. NO.		968TS71800	
A	ADD SPONG&CARTON	10/04/2005	BART	PAIR	SUEDY		UNITS:		SAFETY	
	RELEASE	04/13/2006	PAIR	AL	EUGENE		M/M			
ND	DESCRIPTION	DATE	BY	CHK	APPD		DATE		SHEET 1 OF 1	
REVISIONS							04/13/06		DRAW	
									Pair	



Pb-free Soldering IR Reflow(SMD)



- 1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85%
2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

IR reflow profile		Pb-free
step#	Profile Feature	Condition/Duration
step1	Ramp-up rate	3°C/second max
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds
step3	Ramp-up rate(TL to Tp)	3°C/second max
	Temperature maintained above 217°C	60-150seconds
step4	Peak temperature(Tp)	260+0/-5°C
	Time within 5°C of actual peak temperature	30seconds max
Ramp-down rate(Tp to TL)		6°C/second max

- 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5°C
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5°C
>2.5mm	250+0/-5°C	245+0/-5°C	245+0/-5°C